# SURFACE MOUNT MICRO HEADER 

## ( 1.27 mm ) .050" PITCH • FTSH SERIES

FTSH
Board Mates:
CLP, FLE
Cable Mates:
FFSD, FFTP

## SPECIFICATIONS

Insulator Material:
Black Liquid Crystal Polymer
Terminal Material:
Phosphor Bronze
Plating:
Sn or Au over
$50 \mu^{\prime \prime}(1.27 \mu \mathrm{~m}) \mathrm{Ni}$
Current Rating (FTSH/CLP):
3.4 A per pin
(2 pins powered)
Operating Temp Range:
$-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

## PROCESSING

Lead-Free Solderable: Yes
SMT Lead Coplanarity:
-MT \& -DV Tail Option:
( 0.10 mm ) . 004 " $\max (02-25$ )
-MT \& -DH Tail Option:
( 0.15 mm ) . $006^{\prime \prime} \max (26-50)^{*}$
*(.004" stencil solution
may be available; contact
IPG@samtec.com)

ALSO AVAILABLE MOQ Required
Molded Pick \& Place pads Latches
Other platings


Notes
Some sizes, styles and options are non-standard, non-returnable.

See SFM/TFM for positive alignment feature.

